



SOT1089-1

plastic, extremely thin small outline package; no leads; 8 terminals, 0.35 mm pitch, 1.35 mm x 1 mm x 0.5 mm body

13 August 2021

Package information

1 Package summary

Terminal position code	D (double)
Package type descriptive code	XSON8
Package type industry code	XSON8
Package style descriptive code	XSON (extremely thin small outline; no leads)
Package body material type	P (plastic)
Mounting method type	S (surface mount)
Issue date	30-06-2010
Manufacturer package code	SOT1089-1

Table 1. Package summary

Parameter	Min	Nom	Max	Unit
package length	1.3	1.35	1.4	mm
package width	0.95	1	1.05	mm
seated height	-	-	0.5	mm
nominal pitch	-	0.35	-	mm
actual quantity of termination	-	8	-	



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2 Package outline

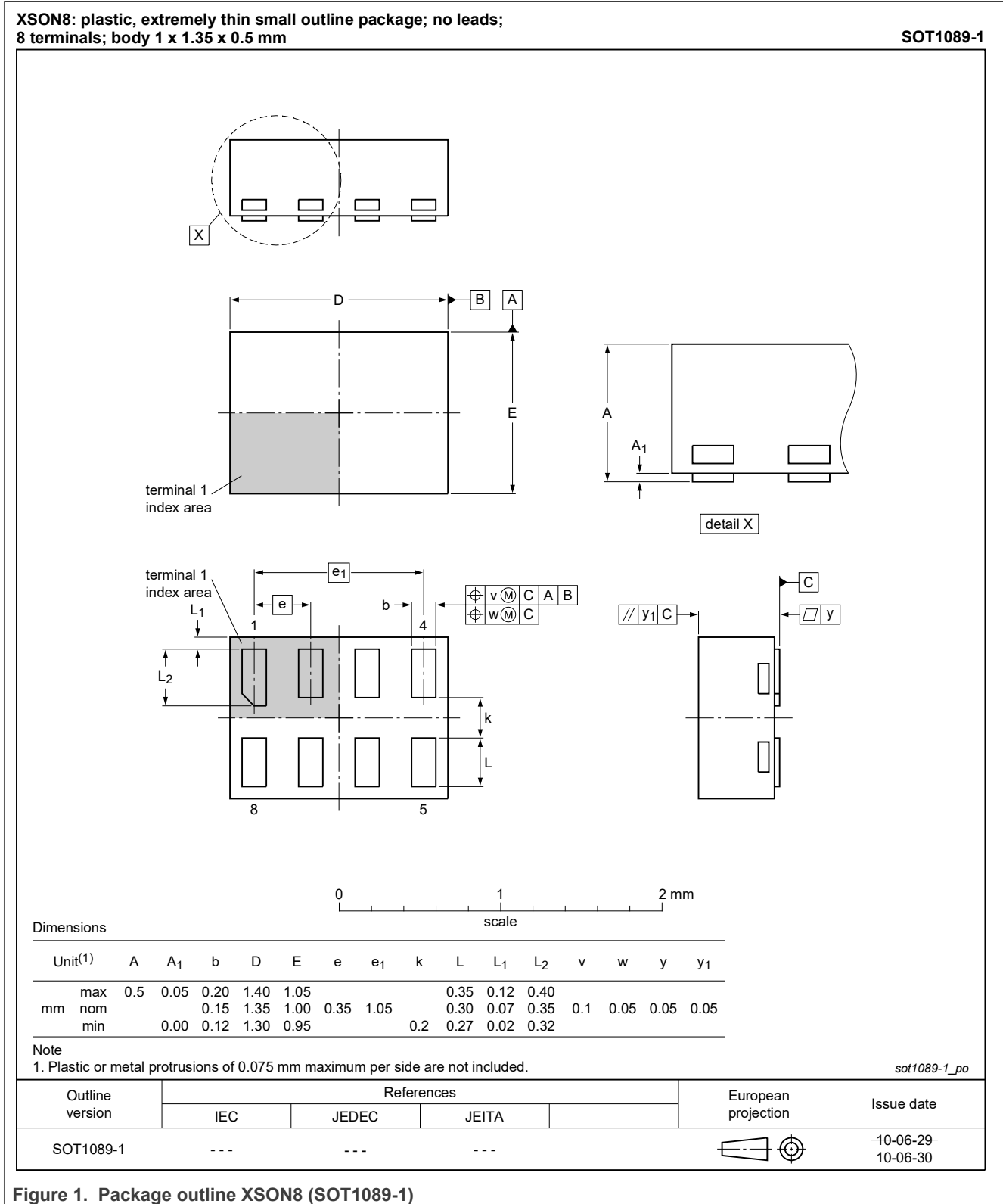


Figure 1. Package outline XSON8 (SOT1089-1)

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3 Legal information

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